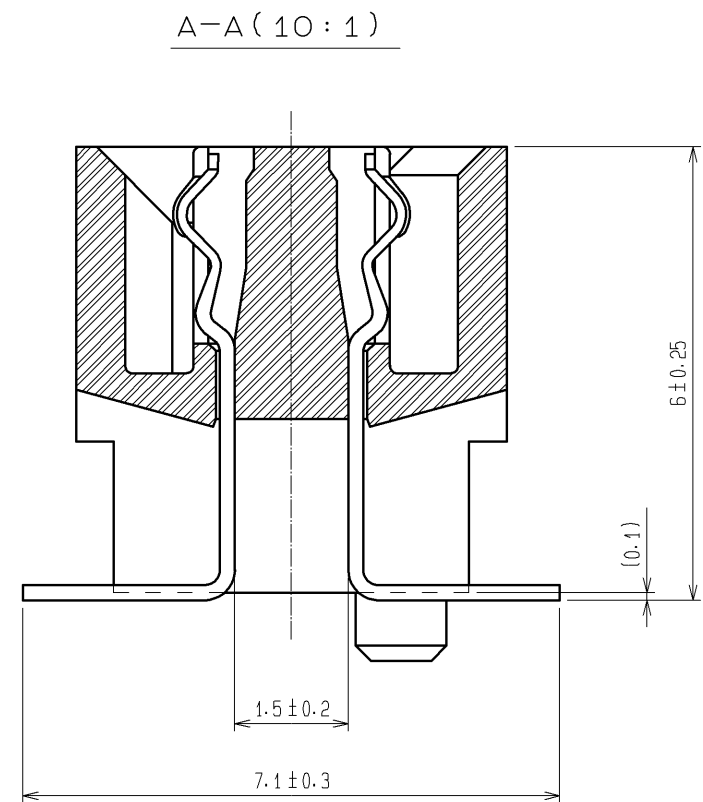
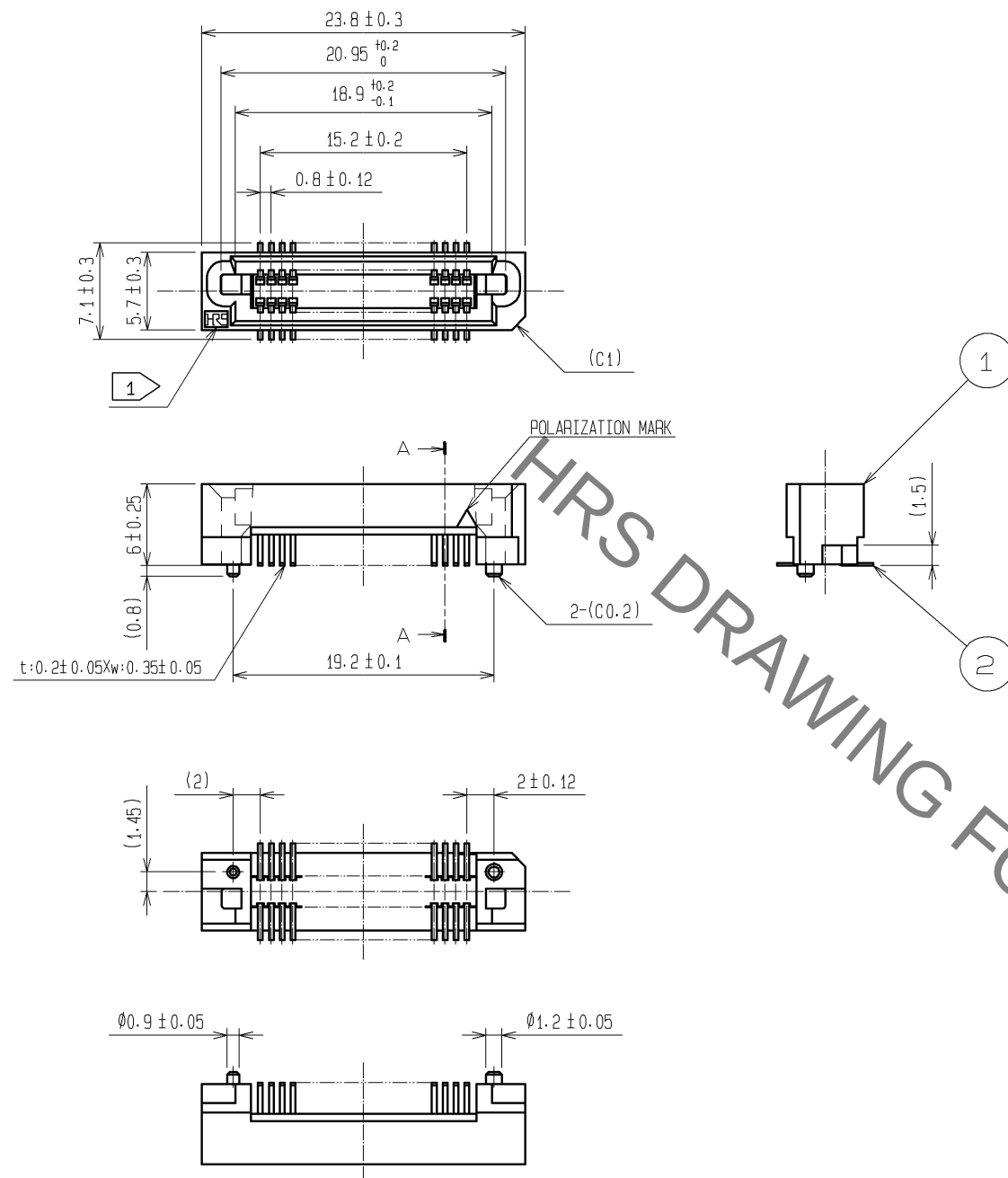
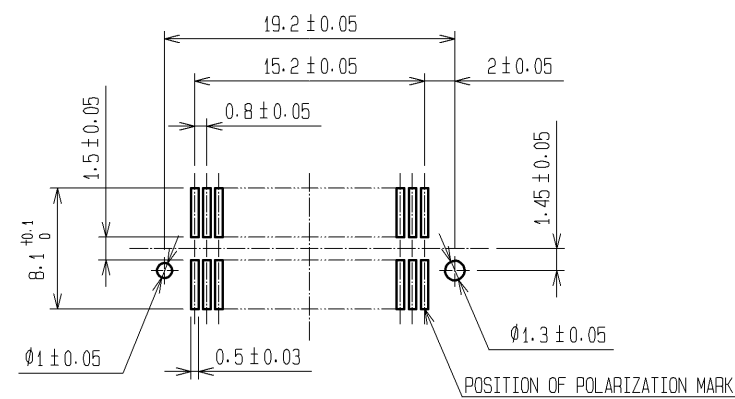


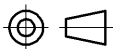


- NOTE
1. HRS MARK SHALL BE OPTIONAL.
 2. LEAD CO-PLANARITY SHALL BE 0.1mm MAX.
 3. EMBOSSED CARRIER TAPE PACKAGING SHALL BE APPLIED FOR THIS PRODUCT. SEE NEXT PAGE FOR DETAILS.
 4. THIS PRODUCT HAS TAPE FOR VACUUM PICKUP. SEE NEXT PAGE FOR DETAIL OF STICKING POSITION, ETC.
 5. FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES.
 6. THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE)
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)



2	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1μm min.			
		LEAD AREA:TIN-PLATING 1μm min.			
		UNDER PLATING:NICKEL 2μm min.			
1	PPS	LIGHT BROWN (UL94V-0)	5	POLYIMIDE	(TAPE FOR VUCUUM PICKUP)
			4	POLYESTER	(TOP COVER TAPE)
			3	POLYSTYRENE	(EMBOSSED CARRIER TAPE)
NO.	MATERIAL	FINISH , REMARKS	NO.	MATERIAL	FINISH , REMARKS

UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED : HS. OKAWA		08. 07. 23	DRAWING NO.	EDC3-084980-23		
		CHECED : HT. YAMAGUCHI		08. 07. 23	PART NO.	FX6-40S-0. 8SV2(93)		
		DESIGNED : SY. KAMIGA		08. 07. 22	CODE NO.	CL576-0123-0-93		
		DRAWN : HK. SUNADORI		08. 07. 17				
								1/2

